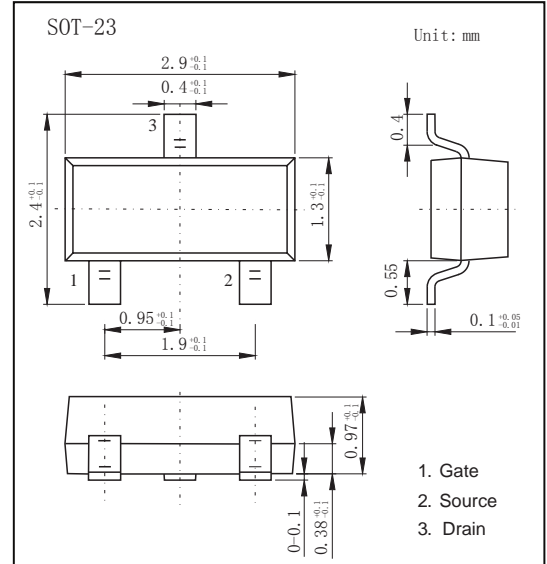


SOT-23 Plastic-Encapsulate MOSFETS
Features

- VDS (V) = 30V
- ID = 5.8 A (VGS = 10V)
- RDS(ON) < 28mΩ (VGS = 10V)
- RDS(ON) < 33mΩ (VGS = 4.5V)
- RDS(ON) < 52mΩ (VGS = 2.5V)
- RDS(ON) < 70mΩ (VGS = 1.8V)
- N-Channel MOSFET

MECHANICAL DATA

- Case style: SOT-23 molded plastic
- Mounting position: any


MAXIMUM RATINGS AND CHARACTERISTICS

@ 25°C Ambient Temperature (unless otherwise noted)

| Parameter | Symbol | Rating | Unit | |
|---|--------|--------------|------|------|
| Drain-Source Voltage | VDS | 30 | V | |
| Gate-Source Voltage | VGS | ±12 | | |
| Continuous Drain Current | ID | TA=25°C | 5.8 | A |
| | | TA=70°C | 4.9 | |
| Pulsed Drain Current | IDM | 30 | | |
| Power Dissipation | PD | TA=25°C | 1.4 | W |
| | | TA=70°C | 1 | |
| Thermal Resistance.Junction- to-Ambient | RthJA | t ≤ 10s | 90 | °C/W |
| | | Steady-State | 125 | |
| Thermal Resistance.Junction- to-Lead | RthJL | 60 | | |
| Junction Temperature | TJ | 150 | °C | |
| Storage Temperature Range | Tstg | -55 to 150 | | |

Mosfet Electrical Characteristics TA=25°C unless otherwise specified)

| Parameter | Symbol | Test Conditions | Min | Typ | Max | Unit |
|---------------------------------------|---------------------|--|-----|-----|------|------|
| Drain-Source Breakdown Voltage | V _{DSS} | I _D =250 μ A, V _{GS} =0V | 30 | | | V |
| Zero Gate Voltage Drain Current | I _{DSS} | V _{DS} =24V, V _{GS} =0V | | | 1 | uA |
| | | V _{DS} =24V, V _{GS} =0V, T _J =55°C | | | 5 | |
| Gate-Body Leakage Current | I _{GSS} | V _{DS} =0V, V _{GS} =±12V | | | ±100 | nA |
| Gate Threshold Voltage | V _{GS(th)} | V _{DS} =V _{GS} , I _D =250 μ A | 0.5 | | 1 | V |
| Static Drain-Source On-Resistance | R _{DS(on)} | V _{GS} =10V, I _D =5.8A | | | 28 | m Ω |
| | | V _{GS} =10V, I _D =5.8A T _J =125°C | | | 39 | |
| | | V _{GS} =4.5V, I _D =5A | | | 33 | |
| | | V _{GS} =2.5V, I _D =4A | | | 42 | |
| | | V _{GS} =1.8V, I _D =3A | | | 72 | |
| On State Drain Current | I _{D(ON)} | V _{GS} =4.5V, V _{DS} =5V | 30 | | | A |
| Forward Transconductance | g _{FS} | V _{DS} =5V, I _D =5A | 12 | 17 | | S |
| Input Capacitance | C _{iss} | V _{GS} =0V, V _{DS} =15V, f=1MHz | | 767 | | pF |
| Output Capacitance | C _{oss} | | | 111 | | |
| Reverse Transfer Capacitance | C _{rss} | | | 82 | | |
| Gate Resistance | R _g | V _{GS} =0V, V _{DS} =0V, f=1MHz | | 1.3 | | Ω |
| Total Gate Charge | Q _g | V _{GS} =4.5V, V _{DS} =15V, I _D =5.8A | | 10 | | nC |
| Gate Source Charge | Q _{gs} | | | 1.2 | | |
| Gate Drain Charge | Q _{gd} | | | 3.1 | | |
| Turn-On DelayTime | t _{d(on)} | V _{GS} =10V, V _{DS} =15V, R _L =2.7 Ω, R _G =6 Ω | | 5 | | ns |
| Turn-On Rise Time | t _r | | | 5.5 | | |
| Turn-Off DelayTime | t _{d(off)} | | | 39 | | |
| Turn-Off Fall Time | t _f | | | 4.7 | | |
| Body Diode Reverse Recovery Time | t _{rr} | I _F = 5A, di/dt= 100A/ μ s | | 15 | | nC |
| Body Diode Reverse Recovery Charge | Q _{rr} | | | 7.1 | | |
| Maximum Body-Diode Continuous Current | I _S | | | | 2.5 | A |
| Diode Forward Voltage | V _{SD} | I _S =1A, V _{GS} =0V | | | 1 | V |